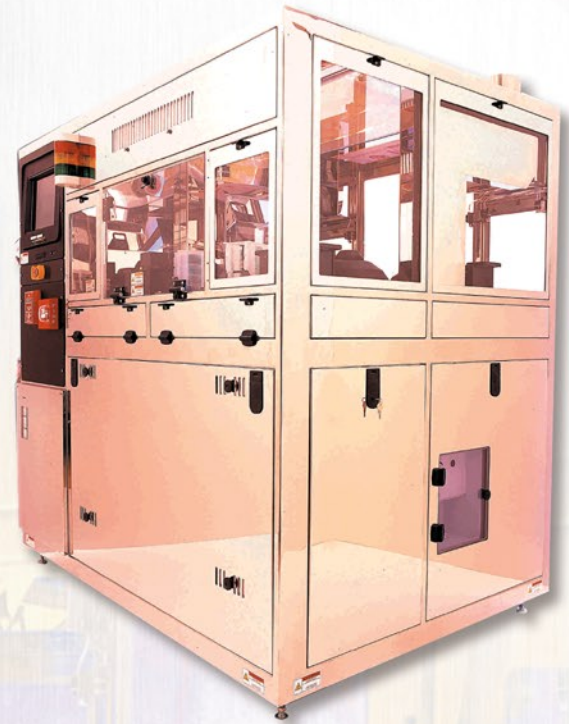


Solid, Affordable & Reliable Plating Technology

The Equinox™ is a modular system that offers diverse processing capability through wet and/or vapor chambers. Available in FRPP and Stainless Steel 2, 4, and 6 chamber standard configurations, the Equinox processes via spray, vapor, immersion, and electroplating.

- Supports Round or Square Substrates from 50mm-200mm
- Device-side-down processing creates a thin, uniform boundary layer
- Processes Traditional and Non-mainstream Materials
 - Quartz
 - Silicon
 - Gallium Arsenide
 - Ceramic
 - Lithium Niobate
 - Indium Phosphide
- Controlled Chemical Distribution and Wafer Rotation
- Precise, Repeatable and Reliable Process and System Control



Solvent/Acid Applications

Polymer Removal
Metal lift-off
Photoresist Strip
Metal Etch
Backside Film Strip
Acid and Solvent Cleans

Native Oxide Pre-clean
Pre-epi Clean
HF Vapor for SiO₂ Removal
Sacrificial Oxide Etch
Bevel Etch

Metal Applications

Gold Electroplating and Deplating
Solder Bump Plating
Copper Damascene Electroplating
Patterned Copper Electroplating

Nickel Electroplating
Tin Electroplating
Platinum Electroplating
Tantalum Anidization

